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TO: OFFICE OF PATENT PUBLICATIONS DATE: JUNE 23, 2004

COMPANY: U.S. PATENT AND TRADEMARK OFFICE

FROM: EUGENE M. LEE, REG. NO. 32,039

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Notice of Allowance Mailed:

In re the Application of:

March 25, 2004

Jeong-sic JEON, et al. .

Art Unit: 1763

Serial No. 10/003,412

Examiner:

Parviz HASSANZADEH

Filed:

December 6, 2001

Confirmation No. 5396

For:

APPARATUS FOR MANUFACTURING SEMICONDUCTOR DEVICE

Transmitted herewith is/are

>AMENDMENT UNDER 37 C.F.R. §1.312

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LEE & STERBA, P.C.

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Attorney Docket No. 249/275

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Mail Stop: ISSUE FEE Commissioner for Patents United States Patent and Trademark Office Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENT

It is respectfully requested that the above-referenced application be returned to the Examiner for consideration and entry of the following amendment:

IN THE SPECIFICATION

Kindly amend the specification as follows:

Page 13, paragraph [0035]

[0035] For a wafer 30 shown in Fig. 1A having a diameter identical to the diameter M3 of the wafer 130 shown in Fig. 2, the diameter M1 of the insulating plate 120 shown in Fig. 2 would preferably be larger than the diameter L1 of an insulating plate 20 in Fig. $\underline{1A}$ 2. Thus, the distance spanned by the plurality of induction coils 114 shown in Fig. 2 would be greater than distance spanned by the plurality of induction coils 14 shown in Fig. 1A.